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MARKING

Quad 3-State Noninverting Buffers

High-Performance Silicon-Gate CMOS

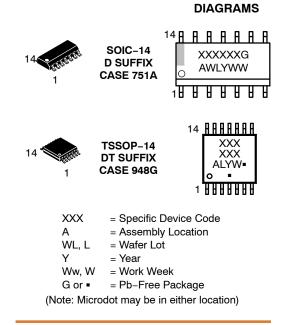
MC74HC125A, MC74HCT125A, MC74HC126A

The MC74HC125A/MC74HCT125A and MC74HC126A are identical in pinout to the LS125 and LS126. The device inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LSTTL outputs. The MC74HCT125A device inputs are compatible with Standard CMOS or TTL outputs.

The HC125A and HC126A noninverting buffers are designed to be used with 3-state memory address drivers, clock drivers, and other bus-oriented systems. The devices have four separate output enables that are active-low (HC125A) or active-high (HC126A).

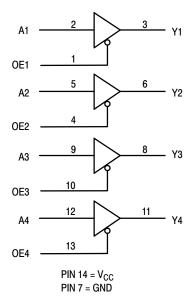
Features

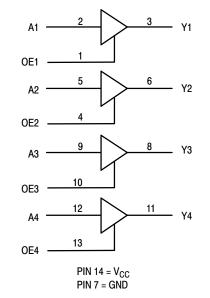
- Output Drive Capability: 15 LSTTL Loads
- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 2.0 to 6.0 V (HC), 4.5 to 5.5 V (HCT)
- Low Input Current: 1.0 μA
- High Noise Immunity Characteristic of CMOS Devices
- In Compliance with the JEDEC Standard No. 7 A Requirements
- Chip Complexity: 72 FETs or 18 Equivalent Gates
- -Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant



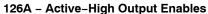
ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.











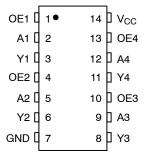


Figure 2. Pinout Diagram

FUNCTION TABLE

	125A			126A		
In	outs	Output		Inputs		Output
Α	OE	Y		Α	OE	Y
н	L	н		н	н	н
L	L	L		L	н	L
Х	Н	Z		Х	L	Z

MAXIMUM RATINGS

Symbol	Parameter	Value	Unit	
V _{CC}	DC Supply Voltage	–0.5 to +6.5	V	
V _{IN}	DC Input Voltage		-0.5 to V_{CC} + 0.5	V
V _{OUT}	DC Output Voltage		-0.5 to V _{CC} + 0.5	V
I _{IN}	DC Input Current, per Pin		±20	mA
I _{OUT}	DC Output Current, per Pin	±35	mA	
I _{CC}	DC Supply Current, V _{CC} and GND Pins	±75	mA	
Ι _{ΙΚ}	Input Clamp Current (V _{IN} < 0 or V _{IN} > V _{CC})		±20	mA
I _{OK}	Output Clamp Current (V _{OUT} < 0 or V _{OUT} > V _{CC})		±20	mA
T _{STG}	Storage Temperature		–65 to +150	°C
ΤL	Lead Temperature, 1 mm from Case for 10 Seconds		260	°C
ТJ	Junction Temperature Under Bias		±150	°C
θ_{JA}	Thermal Resistance (Note 1)	SOIC-14 TSSOP-14	116 150	°C/W
P _D	Power Dissipation in Still Air at 25°C	SOIC-14 TSSOP-14	1077 833	mW
MSL	Moisture Sensitivity		Level 1	-
F _R	Flammability Rating	Oxygen Index: 28 to 34	UL 94 V–0 @ 0.125 in	-
V_{ESD}	ESD Withstand Voltage (Note 2)	Human Body Model Charged Device Model	>2000 N/A	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

 Measured with minimum pad spacing on an FR4 board, using 76mm-by-114mm, 2-ounce copper trace no air flow per JESD51-7.
 HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
MC74HC				
V _{CC}	DC Supply Voltage (Referenced to GND)	2.0	6.0	V
V _{IN} , V _{OUT}	DC Input Voltage, Output Voltage (Referenced to GND) (Note 3)	0	V _{CC}	V
T _A	Operating Free-Air Temperature	55	+125	°C
t _r , t _f	Input Rise or Fall Time $V_{CC} = 2.0$ $V_{CC} = 4.5$ $V_{CC} = 6.0$	V 0 V 0 V 0	1000 500 400	ns

MC74HCT

V _{CC}	DC Supply Voltage (Referenced to GND)	4.5	5.5	V
$V_{\text{IN}}, V_{\text{OUT}}$	DC Input Voltage, DC Output Voltage (Referenced to GND) (Note 3)	0	V _{CC}	V
T _A	Operating Free–Air Temperature	-55	+125	°C
t _r , t _f	Input Rise or Fall Time	0	500	ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.
Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

				Guaranteed Limit			
			V _{cc}	–55 to			
Symbol	Parameter	Test Conditions	v	25°C	≤ 85°C	≤ 125°C	Unit
VIH	Minimum High-Level Input Voltage	$V_{out} = V_{CC} - 0.1 V$	2.0	1.5	1.5	1.5	V
		$ I_{out} \le 20 \mu A$	3.0	2.1	2.1	2.1	
			4.5	3.15	3.15	3.15	
			6.0	4.2	4.2	4.2	
VIL	Maximum Low-Level Input Voltage	$V_{out} = 0.1 V$	2.0	0.5	0.5	0.5	V
		$ I_{out} \le 20 \mu A$	3.0	0.9	0.9	0.9	
			4.5	1.35	1.35	1.35	
			6.0	1.8	1.8	1.8	
V _{OH}	Minimum High-Level Output	$V_{in} = V_{IH} \text{ or } V_{IL}$					V
	Voltage	I _{out} ≤ 20 μA	2.0	1.9	1.9	1.9	
			4.5	4.4	4.4	4.4	
			6.0	5.9	5.9	5.9	
		$ I_{out} \le 3.6 \text{ mA}$	3.0	2.48	2.34	2.2	
		$ I_{out} \le 6.0 \text{ mA}$	4.5	3.98	3.84	3.7	
		$ I_{out} \leq 7.8 \text{ mA}$	6.0	5.48	5.34	5.2	
V _{OL}	Maximum Low-Level Output	$V_{in} = V_{IH} \text{ or } V_{IL}$					V
	Voltage	I _{out} ≤ 20 μA	2.0	0.1	0.1	0.1	
			4.5	0.1	0.1	0.1	
			6.0	0.1	0.1	0.1	
		$ I_{out} \le 3.6 \text{ mA}$	3.0	0.26	0.33	0.4	
		$ I_{out} \le 6.0 \text{ mA}$	4.5	0.26	0.33	0.4	
		$ I_{out} \leq 7.8 \text{ mA}$	6.0	0.26	0.33	0.4	
l _{in}	Maximum Input Leakage Current	V _{in} = V _{CC} or GND	6.0	±0.1	±1.0	±1.0	μΑ
I _{OZ}	Maximum Three-State Leakage	Output in High-Impedance State	6.0	±0.5	±5.0	±10	μA
	Current	$V_{in} = V_{IL} \text{ or } V_{IH}$					
		V _{out} = V _{CC} or GND					
I _{CC}	Maximum Quiescent Supply Current		6.0	4.0	40	160	μA
	(per Package)	I _{out} = 0 μA					

DC ELECTRICAL CHARACTERISTICS (MC74HC125A, MC74HC126A)

AC ELECTRICAL CHARACTERISTICS (MC74HC125A, MC74HC126A)

			Guaranteed Limit			
Symbol	Parameter	V _{CC} V	–55 to 25°C	≤ 85°C	≤ 125°C	Unit
t _{PLH} ,	Maximum Propagation Delay, Input A to Output Y	2.0	90	115	135	ns
t _{PHL}	(Figure 4)	3.0	36	45	60	
		4.5	18	23	27	
		6.0	15	20	23	
t _{PLZ} ,	Maximum Propagation Delay, Output Enable to Y	2.0	120	150	180	ns
t _{PHZ}	(Figure 4)	3.0	45	60	80	
		4.5	24	30	36	
		6.0	20	26	31	
t _{PZL} ,	Maximum Propagation Delay, Output Enable to Y	2.0	90	115	135	ns
t _{PZH}	(Figure 4)	3.0	36	45	60	
		4.5	18	23	27	
		6.0	15	20	23	
t _{TLH} ,	Maximum Output Transition Time, Any Output	2.0	60	75	90	ns
t _{THL}	(Figure 4)	3.0	22	28	34	
		4.5	12	15	18	
		6.0	10	13	15	
C _{in}	Maximum Input Capacitance	-	10	10	10	pF
Cout	Maximum 3-State Output Capacitance (Output in High-Impedance State)	-	15	15	15	pF
			Ту	vpical @ 25°	°C	
C _{PD}	Power Dissipation Capacitance (Per Enabled Output) (Note 4)	5.0		30		pF

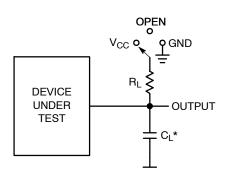
4. Used to determine the no–load dynamic power consumption: $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$.

DC ELECTRICAL CHARACTERISTICS (MC74HCT125A)

				Gu	aranteed Li	mit		
Symbol	Parameter	Test Conditions		cc V	– 55 to 25°C	≤ 85°C	≤ 125°C	Unit
V _{IH}	Minimum High-Level Input Volta	$\begin{array}{ll} ge & V_{out}=0.1 \ V \ or \ V_{CC}-0.1 \ V \\ I_{out} \ \leq \ 20 \ \mu A \end{array}$.5 .5	2.0 2.0	2.0 2.0	2.0 2.0	V
V _{IL}	$ \begin{array}{ l l l l l l l l l l l l l l l l l l l$.5 .5	0.8 0.8	0.8 0.8	0.8 0.8	V
V _{OH}	Minimum High-Level Output Voltage	$\frac{V_{in} = V_{IH} \text{ or } V_{IL}}{ I_{out} \le 20 \ \mu\text{A}}$ $\frac{ I_{out} \le 6.0 \ \text{mA}}{ I_{out} \le 6.0 \ \text{mA}}$	5	.5 .5 .5	4.4 5.4 3.98	4.4 5.4 3.84	4.4 5.4 3.7	V
V _{OL}	Maximum Low-Level Output Voltage	$V_{in} = V_{IH} \text{ or } V_{IL}$ $ I_{out} \le 20 \ \mu\text{A}$ $ I_{out} \le 6.0 \ \text{mA}$	5	.5 .5 .5	0.1 0.1 0.26	0.1 0.1 0.33	0.1 0.1 0.4	V
l _{in}	Maximum Input Leakage Currer	t V _{in} = V _{CC} or GND	5	.5	±0.1	±1.0	±1.0	μA
I _{OZ}	Maximum Three-State Leakage Current	Output in High-Impedance State $V_{in} = V_{IL} \text{ or } V_{IH}$ $V_{out} = V_{CC} \text{ or GND}$	te 5	.5	±0.5	±5.0	±10	μA
I _{CC}			5	.5	2.0	20	80	μA
ΔI_{CC}	Supply Current V	$_{N}$ = 2.4 V; Any One Input $_{N}$ = V _{CC} or GND, Other Inputs;	5.5		≥ –55°C	25°C	C to 125°C	
	l lo	T = 0 μA			2.9		2.4	m

AC ELECTRICAL CHARACTERISTICS (MC74HCT125A)

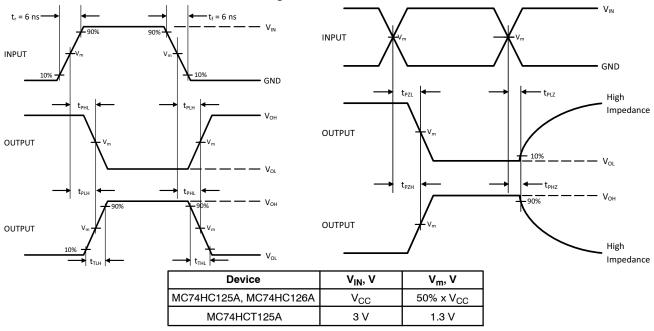
			Guaranteed Limit			
Symbol	Parameter	v _{cc} v	– 55 to 25°C	≤ 85°C	≤ 125°C	Unit
t _{PLH} , t _{PHL}	Maximum Propagation Delay, Input A to Output Y (Figure 4)	5.0	18	23	27	ns
t _{PLZ} , t _{PHZ}	Maximum Propagation Delay, Output Enable to Y (Figure 4)	5.0	24	30	36	ns
t _{PZL} , t _{PZH}	Maximum Propagation Delay, Output Enable to Y (Figure 4)	5.0	18	23	27	ns
t _{TLH} , t _{THL}	Maximum Output Transition Time, Any Output (Figure 4)	5.0	12	15	18	ns
C _{in}	Maximum Input Capacitance	-	10	10	10	pF
Cout	Maximum 3-State Output Capacitance (Output in High-Impedance State)	-	15	15	15	pF
			Typical @ 25°C		°C	
C _{PD}	Power Dissipation Capacitance (Per Enabled Output) (Note 4)	5.0		30		pF



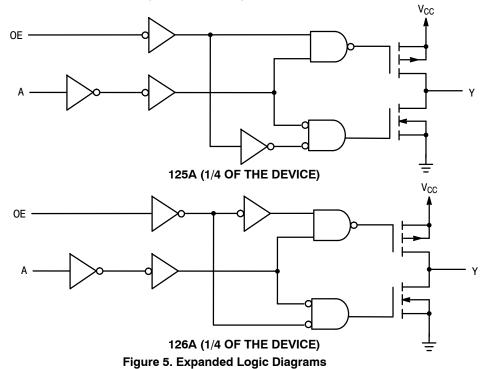
Test	Switch Position	CL	RL
t _{PLH} / t _{PHL}	Open	50 pF	1 kΩ
t _{PLZ} / t _{PZL}	V _{CC}		
t _{PHZ} / t _{PZH}	GND		

*CL Includes probe and jig capacitance









ORDERING INFORMATION

Device	Package	Marking	Shipping [†]
MC74HC125ADG	SOIC-14	HC125A	55 Units / Rail
MC74HC125ADR2G	SOIC-14	HC125A	2500 / Tape & Reel
MC74HC125ADR2G-Q*	SOIC-14	HC125A	2500 / Tape & Reel
MC74HC125ADTG	TSSOP-14	HC 125A	2500 / Tape & Reel
MC74HC125ADTR2G	TSSOP-14	HC 125A	2500 / Tape & Reel
MC74HC125ADTR2G-Q*	TSSOP-14	HC 125A	2500 / Tape & Reel
MC74HCT125ADR2G	SOIC-14	HCT125A	2500 / Tape & Reel
MC74HCT125ADR2G-Q*	SOIC-14	HCT125A	2500 / Tape & Reel
MC74HCT125ADTR2G	TSSOP-14	HCT 125A	2500 / Tape & Reel
MC74HCT125ADTR2G-Q*	TSSOP-14	HCT 125A	2500 / Tape & Reel
MC74HC126ADR2G	SOIC-14	HC126A	2500 / Tape & Reel
MC74HC126ADR2G-Q*	SOIC-14	HC126A	2500 / Tape & Reel
MC74HC126ADTR2G	4HC126ADTR2G TSSOP-14 HC 126/		2500 / Tape & Reel
MC74HC126ADTR2G-Q*	TSSOP-14	HC 126A	2500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. *-Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP

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*For additional information on our Pb–Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DATE 03 FEB 2016

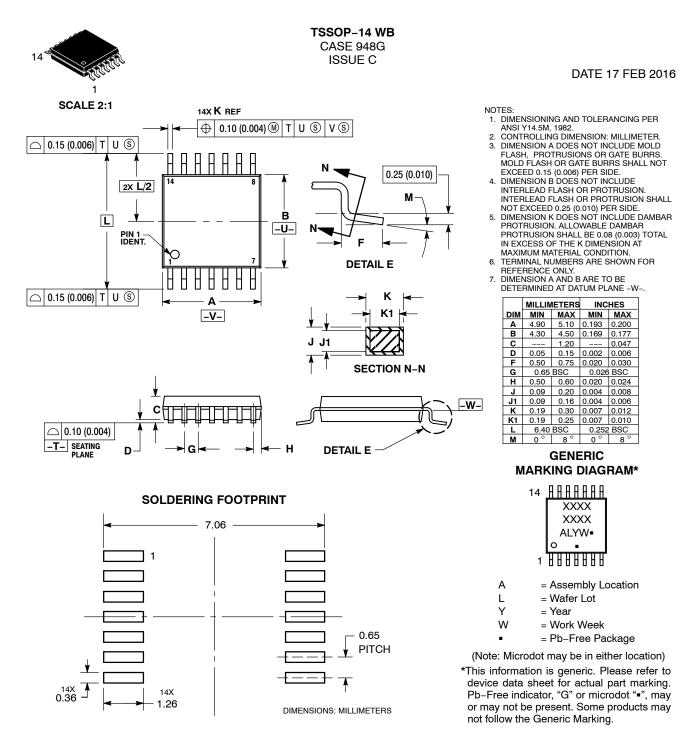
STYLE 1: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. NO CONNECTION 7. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. NO CONNECTION 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 2: CANCELLED	STYLE 3: PIN 1. NO CONNECTION 2. ANODE 3. ANODE 4. NO CONNECTION 5. ANODE 6. NO CONNECTION 7. ANODE 8. ANODE 9. ANODE 10. NO CONNECTION 11. ANODE 12. ANODE 13. NO CONNECTION 14. COMMON CATHODE	STYLE 4: PIN 1. NO CONNECTION 2. CATHODE 3. CATHODE 4. NO CONNECTION 5. CATHODE 6. NO CONNECTION 7. CATHODE 8. CATHODE 10. NO CONNECTION 11. CATHODE 12. CATHODE 13. NO CONNECTION 14. COMMON ANODE
STYLE 5: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. NO CONNECTION 7. COMMON ANODE 8. COMMON CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 6: PIN 1. CATHODE 2. CATHODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE 7. CATHODE 8. ANODE 9. ANODE 10. ANODE 11. ANODE 12. ANODE 13. ANODE 14. ANODE	STYLE 7: PIN 1. ANODE/CATHODE 2. COMMON ANODE 3. COMMON CATHODE 4. ANODE/CATHODE 5. ANODE/CATHODE 6. ANODE/CATHODE 7. ANODE/CATHODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. COMMON CATHODE 12. COMMON CATHODE 13. ANODE/CATHODE 14. ANODE/CATHODE	STYLE 8: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. ANODE/CATHODE 7. COMMON ANODE 9. ANODE/CATHODE 10. ANODE/CATHODE 11. NO CONNECTION 12. ANODE/CATHODE 13. ANODE/CATHODE 14. COMMON CATHODE

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